TOSHIBA CMOS Digital Integrated Circuit Silicon Monolithic

# **TC74LCX16244AFT**

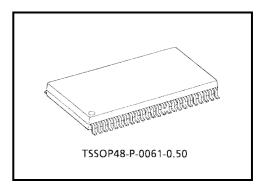
#### Low-Voltage 16-Bit Bus Buffer with 5-V Tolerant Inputs and Outputs

The TC74LCX16244AFT is a high-performance CMOS 16-bit bus buffer. Designed for use in 3.3-V systems, it achieves high-speed operation while maintaining the CMOS low power dissipation.

The device is designed for low-voltage (3.3 V) VCC applications, but it could be used to interface to 5 V supply environment for both inputs and outputs.

This device is non-inverting 3-state buffer having four active-low output enables. It can be used as four 4-bit buffers two 8-bit buffers or one 16-bit buffer. When the  $\overline{\rm OE}$  input is high, the outputs are in a high-impedance state. This device is designed to be used with 3-state memory address drivers, etc.

All inputs are equipped with protection circuits against static discharge.

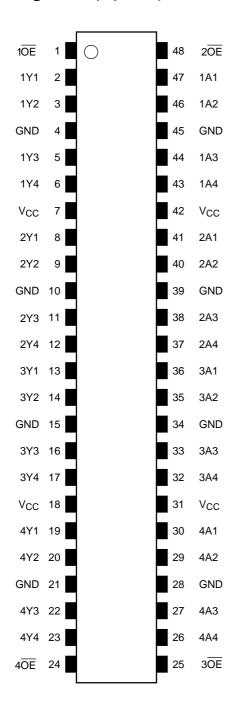


Weight: 0.25 g (typ.)

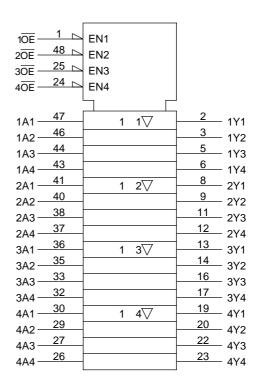
#### **Features**

- Low-voltage operation:  $V_{CC} = 2.0$  to 3.6 V
- High-speed operation:  $t_{pd} = 5.2 \text{ ns (max)} (V_{CC} = 3.0 \text{ to } 3.6 \text{ V})$
- Output current:  $|I_{OH}|/I_{OL} = 24 \text{ mA (min)} (V_{CC} = 3.0 \text{ V})$
- Latch-up performance: ±500 mA
- Package: TSSOP (thin shrink small outline package)
- Power-down protection provided on all inputs and outputs

### Pin Assignment (top view)



## **IEC Logic Symbol**



### **Truth Table**

Inp	Outputs	
1 <del>OE</del>	1A1-1A4	1Y1-1Y4
L	L	L
L	Н	Н
Н	Х	Z

Inp	uts	Outputs
2 <del>OE</del>	2A1-2A4	2Y1-2Y4
L	L	L
L	Н	Н
Н	Х	Z

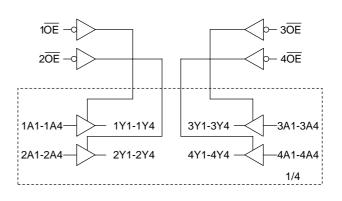
Inp	uts	Outputs
3 <del>OE</del>	3A1-3A4	3Y1-3Y4
L	L	L
L	Н	Н
Н	Х	Z

Inp	uts	Outputs
4 <del>OE</del>	4A1-4A4	4Y1-4Y4
L	L	L
L	Н	Н
Н	Х	Z

X: Don't care

Z: High impedance

# **System Diagram**





## **Maximum Ratings**

Characteristics	Symbol	Rating	Unit
Power supply voltage	V <sub>CC</sub>	-0.5 to 7.0	V
Input voltage	V <sub>IN</sub>	-0.5 to 7.0	٧
		-0.5 to 7.0 (Note 1)	
Output voltage	V <sub>OUT</sub>	-0.5 to V <sub>CC</sub> + 0.5	V
		(Note 2)	
Input diode current	I <sub>IK</sub>	-50	mA
Output diode current	I <sub>OK</sub>	±50 (Note 3)	mA
DC output current	lout	±50	mA
Power dissipation	P <sub>D</sub>	400	mW
DC V <sub>CC</sub> /ground current per supply pin	I <sub>CC</sub> /I <sub>GND</sub>	±100	mA
Storage temperature	T <sub>stg</sub>	-65 to 150	°C

Note 1: Output in OFF state

Note 2: High or low state.  $I_{\mbox{OUT}}$  absolute maximum rating must be observed.

Note 3:  $V_{OUT} < GND, V_{OUT} > V_{CC}$ 

## **Recommended Operating Conditions**

Characteristics	Symbol	Rating	Unit	
Power supply voltage	V <sub>CC</sub>	2.0 to 3.6		
Tower supply voltage	vcc vcc	1.5 to 3.6 (Note 4)	V	
Input voltage	V <sub>IN</sub>	0 to 5.5	V	
Output voltage	Vour	0 to 5.5 (Note 5)	V	
Output voltage	Vout	0 to V <sub>CC</sub> (Note 6)		
Output current	I <sub>OH</sub> /I <sub>OI</sub>	±24 (Note 7)	mA	
Output current	'OH/'OL	±12 (Note 8)	ША	
Operating temperature	T <sub>opr</sub>	-40 to 85	°C	
Input rise and fall time	dt/dv	0 to 10 (Note 9)	ns/V	

Note 4: Data retention only

Note 5: Output in OFF state

Note 6: High or low state

Note 7:  $V_{CC} = 3.0 \text{ to } 3.6 \text{ V}$ 

Note 8:  $V_{CC} = 2.7 \text{ to } 3.0 \text{ V}$ 

Note 9:  $V_{IN} = 0.8$  to 2.0 V,  $V_{CC} = 3.0$  V



### **Electrical Characteristics**

## DC Characteristics (Ta = -40 to 85°C)

Characteris	ation.	Cumbal	Toot (	Test Condition			Max	Lloit	
Characteris	SUCS	Symbol	Test	l est Condition		Min	IVIAX	Unit	
Input voltage	H-level	V <sub>IH</sub>		_	2.7 to 3.6	2.0	_	V	
input voltage	L-level	V <sub>IL</sub>		_	2.7 to 3.6		0.8	V	
				I <sub>OH</sub> = -100 μA	2.7 to 3.6	V <sub>CC</sub> - 0.2	_		
	H-level	V <sub>OH</sub>	V <sub>IN</sub> = V <sub>IH</sub> or V <sub>IL</sub>	$I_{OH} = -12 \text{ mA}$	2.7	2.2			
				$I_{OH} = -18 \text{ mA}$	3.0	2.4	_		
Output voltage				$I_{OH} = -24 \text{ mA}$	3.0	2.2	_	V	
			V V 5-V	$I_{OL} = 100 \mu A$	2.7 to 3.6	_	0.2		
	L-level			I <sub>OL</sub> = 12 mA	2.7	_	0.4		
	L-ievei	V <sub>OL</sub>	$V_{IN} = V_{IH}$ or $V_{IL}$	I <sub>OL</sub> = 16 mA	3.0	_	0.4		
				I <sub>OL</sub> = 24 mA	3.0	_	0.55		
Input leakage currer	nt	I <sub>IN</sub>	V <sub>IN</sub> = 0 to 5.5 V	V <sub>IN</sub> = 0 to 5.5 V		_	±5.0	μА	
2 state output off st	output off-state current		$V_{IN} = V_{IH}$ or $V_{IL}$		2.7 to 3.6		±5.0	^	
3-state output off-state current		loz	V <sub>OUT</sub> = 0 to 5.5 V		2.7 10 3.6	_	±5.0	μА	
Power off leakage c	urrent	I <sub>OFF</sub>	V <sub>IN</sub> /V <sub>OUT</sub> = 5.5 V		0	_	10.0	μА	
Quiescent supply current I <sub>Ct</sub>		laa	$V_{IN} = V_{CC}$ or GND		2.7 to 3.6	_	20.0		
Quiescent supply co	mem	I <sub>CC</sub>	V <sub>IN</sub> /V <sub>OUT</sub> = 3.6 to 5.5 V		$V_{IN}/V_{OUT} = 3.6 \text{ to } 5.5 \text{ V}$ 2.7	2.7 to 3.6	_	±20.0	μΑ
Increase in Icc per i	nput	$\Delta I_{CC}$	$V_{IH} = V_{CC} - 0.6 V$		2.7 to 3.6	_	500		

# AC Characteristics ( $Ta = -40 \text{ to } 85^{\circ}\text{C}$ )

Characteristics	Symbol	Test Condition	V <sub>CC</sub> (V)	Min	Max	Unit
Propagation delay time	t <sub>pLH</sub>	Figure 1, Figure 2	2.7	_	6.2	ns
i Topagation delay time	t <sub>pHL</sub>		$3.3 \pm 0.3$	1.5	5.2	113
3-state output enable time	t <sub>pZL</sub>	Figure 1, Figure 3	2.7	_	7.5	ns
	t <sub>pZH</sub>		$3.3 \pm 0.3$	1.5	6.5	
3-state output disable time	t <sub>pLZ</sub>	Figure 1, Figure 3	2.7	_	6.5	ns
3-state output disable time	t <sub>pHZ</sub>	rigure 1, rigure 3	$3.3 \pm 0.3$	1.5	5.5	115
Output to output skew	t <sub>osLH</sub>	(Note 10)	2.7	_	_	nc
	t <sub>osHL</sub>	(Note 10)	$3.3 \pm 0.3$	_	1.0	ns

Note 10: Parameter guaranteed by design.

 $(t_{OSLH} = |t_{PLHm} - t_{PLHn}|, t_{OSHL} = |t_{PHLm} - t_{PHLn}|)$ 

### **Dynamic Switching Characteristics**

(Ta = 25°C, input:  $t_r = t_f = 2.5 \text{ ns}$ ,  $C_L = 50 \text{ pF}$ ,  $R_L = 500 \Omega$ )

Characteristics		Symbol	Test Condition	V <sub>CC</sub> (V)	Тур.	Unit
Quiet output maximum dynamic	V <sub>OL</sub>	V <sub>OLP</sub>	$V_{IH} = 3.3 \text{ V}, V_{IL} = 0 \text{ V}$	3.3	0.8	V
Quiet output minimum dynamic	V <sub>OL</sub>	V <sub>OLV</sub>	V <sub>IH</sub> = 3.3 V, V <sub>IL</sub> = 0 V	3.3	0.8	V

## **Capacitive Characteristics (Ta = 25°C)**

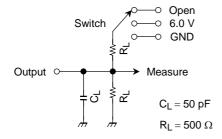
Characteristics	Symbol	Test Condition		V <sub>CC</sub> (V)	Тур.	Unit
Input capacitance	C <sub>IN</sub>			3.3	7	pF
Output capacitance	C <sub>OUT</sub>			3.3	8	pF
Power dissipation capacitance	$C_{PD}$	$f_{IN} = 10 \text{ MHz}$	Note 11)	3.3	25	pF

Note 11: C<sub>PD</sub> is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load.

Average operating current can be obtained by the equation:

 $I_{CC (opr)} = C_{PD} \cdot V_{CC} \cdot f_{IN} + I_{CC}/16 \text{ (per bit)}$ 

#### **AC Test Circuit**



Parameter	Switch
t <sub>pLH</sub> , t <sub>pHL</sub>	Open
t <sub>pLZ</sub> , t <sub>pZL</sub>	6.0 V
t <sub>pHZ</sub> , t <sub>pZH</sub>	GND

Figure 1

#### **AC Waveform**

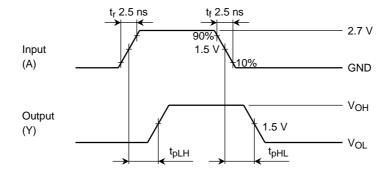
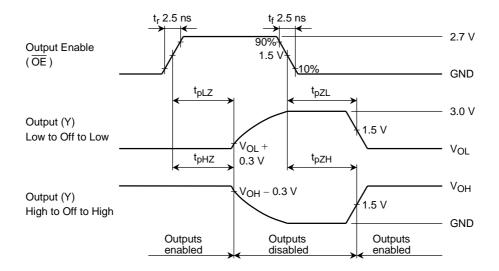


Figure 2 tpLH, tpHL

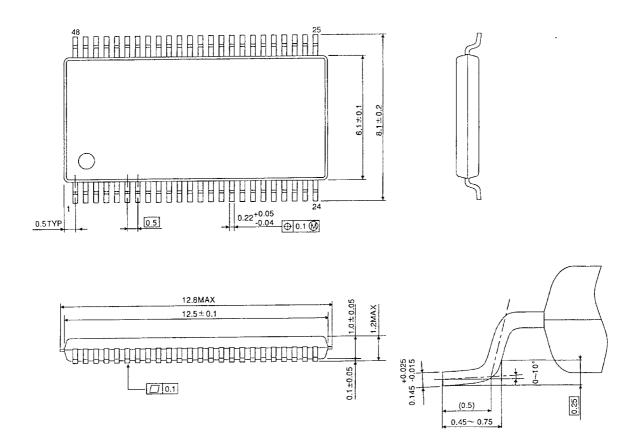


 $Figure \ 3 \quad t_{pLZ}, \, t_{pHZ}, \, t_{pZL}, \, t_{pZH}$ 

Unit: mm

## **Package Dimensions**

TSSOP48-P-0061-0.50



Weight: 0.25 g (typ.)

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